

Dual Channel TVS Diode

- ESD / transient protection for data and power lines to IEC61000-4-2 (ESD): ± 15 KV (contact) IEC61000-4-4 (EFT): 40 A (5/50 ns)
- Working voltage: -8 / +14 V
- Low capacitance
- Low reverse current



ESD8V0L2B-03L

Туре	Package	Configuration	Marking
ESD8V0L2B-03L*	TSLP-3-1	2 channel, bi-directional	B3

* Preliminary data

Maximum Ratings at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Value	Unit
ESD contact discharge ¹⁾	V _{ESD}	15	kV
Peak pulse current ($t_p = 8 / 20 \ \mu s)^{2}$)	I _{pp}	1	А
Operating temperature range	T _{op}	-55125	°C
Storage temperature	T _{stg}	-65150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ³⁾	R _{thJS}	≤ tbd	K/W

 $^{1}\mathrm{V}_{\mathrm{ESD}}$ according to IEC61000-4-2

 ${}^{2}I_{pp}$ according to IEC61000-4-5

 3 For calculation of $R_{\rm thJA}$ please refer to Application Note Thermal Resistance



Parameter	Symbol	Values		Unit	
		min.	typ.	max.	
Characteristics		-			
Reverse working voltage	V _{RWM}	-8	-	14	V
Breakdown voltage	V _(BR)				
I _(BR) = 1 mA, from pin 1 or 2 to pin 3		14.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 3 to pin 1 or pin 2		8.5	-	-	
Reverse current	I _R	-	< 1	100	nA
$V_{\rm R}$ = 3 V, between all pins					
Clamping voltage	V _{CL}				V
V _{ESD} = +15 kV (contact) ¹⁾		-	26	-	
V _{ESD} = -15 kV (contact) ¹⁾		-	20	-	
Diode capacitance	CT	-	4	7	pF
$V_{\rm R}$ = 0 V, <i>f</i> = 1 MHz, from pin 1 or pin 2 to pin 3					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 $^{1}V_{\text{ESD}}$ according to IEC61000-4-2



Reverse current $I_{R} = f(V_{R})$

 T_A = Parameter



Diode capacitance $C_{T} = f(V_{R})$

f = 1 MHz





Application example ESD8V0L2B-03L

2 channel, bi-directional







Foot Print

For board assembly information please refer to Infineon website "Packages"





Stencil apertures

Marking Layout





Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel





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